

● Part Numbering

Chip Inductors (Chip Coils)(SMD)

(Part Number)

LQ	H	32	M	N	331	K	2	3	L
1	2	3	4	5	6	7	8	9	10

① Product ID

Product ID	
LQ	Chip Inductors (Chip Coils)

② Structure

Code	Structure
G	Multilayer Type (Air-core Inductor (Coil))
H	Wire Wound Type (Ferrite Core)
M	Multilayer Type (Ferrite Core)
P	Film Type
W	Wire Wound Type (Air-core Inductor (Coil))
	Wire Wound Type (Ferrite Core)

③ Dimensions (L×W)

Code	Dimensions (L×W)	EIA
02	0.4×0.2mm	01005
03	0.6×0.3mm	0201
04	0.8×0.4mm	03015
15	1.0×0.5mm	0402
18	1.6×0.8mm	0603
21	2.0×1.25mm	0805
2B	2.0×1.5mm	0805
2M	2.0×1.6mm	0806
2H	2.5×2.0mm	1008
2U	2.5×2.0mm	1008
3N	3.0×3.0mm	1212
31	3.2×1.6mm	1206
32	3.2×2.5mm	1210
43	4.5×3.2mm	1812
44	4.0×4.0mm	1515
5B	5.0×5.0mm	2020
55	5.7×5.0mm/5.87×5.2mm	2220
6P	6.0×6.0mm	2424
66	6.3×6.3mm	2525
88	8.0×8.0mm	3131

④ Applications and Characteristics

Code	Series	Applications and Characteristics
H	LQG	Multilayer Air-core Inductor (Coil)
N	LQM	for Resonant Circuit
D		for Choke (Low-current DC Power Supplies)
F		for Choke (DC Power Supplies)
M	LQP	Film Type
T		Film Type (Low DC Resistance Type)
A	LQW	High Q Type (UHF-SHF)
H		High Q Type (VHF-UHF)
C		for Choke
N	LQH	for Resonant Circuit
M		for Resonant Circuit (Coating Type)
D		for Choke
C		for Choke (Coating Type)
S		for Choke (Magnetically Shielded Type)
H		for High-frequency Resonant Circuit
P	LQM/LQH	for Power Line

⑤ Category

Code	Category
N	Standard Type
S	

⑥ Inductance

Expressed by three-digit alphanumerics. The unit is micro-henry (μH). The first and second figures are significant digits, and the third figure expresses the number of zeros which follow the two figures. If there is a decimal point, it is expressed by the capital letter "R". In this case, all figures are significant digits. If inductance is less than 0.1μH, the inductance code is expressed by a combination of two figures and the capital letter "N", and the unit of inductance is nano-henry (nH). The capital letter "N" indicates the unit of "nH", and also expresses a decimal point. In this case, all figures are significant digits.

⑦ Inductance Tolerance

Code	Inductance Tolerance
B	±0.1nH
C	±0.2nH
D	±0.5nH
G	±2%
H	±3%
J	±5%
K	±10%
M	±20%
N	±30%
S	±0.3nH
W	±0.05nH

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(Part Number) **LQ H 32 M N 331 K 2 3 L**
1 2 3 4 5 6 7 8 9 10

⑧ Features (Except LQH□□P/LQM□□P)

Code	Features	Series
0	Standard Type	LQG/LQP/LQW/LQM*1/LQH*2
1	High-Q/ Low DC Resistance	LQW15A/18A/2BH
	Standard Type	LQM21N
2	Standard Type	LQH32C/32M
3	Low DC Resistance	LQH32C
5	Low Profile Type	LQH2MC/32C
7	Large Current Type	LQM21F
8	Low DC Resistance /Large Current Type	

*1 Except LQM21N Series

*2 Except LQH32 Series

⑧ Thickness (LQH□□P/LQM□□P Only · Except LQH6PP/LQH88P)

Code	Dimensions (T)
C	0.5mm
E	0.7mm
0	0.85mm
G	0.9mm
J	1.1mm
M	1.4mm
N	1.55mm
P	1.65mm
R	1.85mm
T	2.0mm

⑩ Packaging

Code	Packaging	Series
K	Embossed Taping (ø330mm Reel)	LQH*1 /LQW□□H*6 /LQM31F/LQM21*2
L	Embossed Taping (ø180mm Reel)	LQH/LQW2BA/LQW2UA/LQW□□H/LQM31F/LQM21*2 /LQM31P/ LQM2HP/LQM2MP
B	Bulk	LQH2MC/LQW/LQG/LQM/LQP
J	Paper Taping (ø330mm Reel)	LQW18A/LQG/LQM18/LQM21*3 /LQP*5
D	Paper Taping (ø180mm Reel)	LQW□□A*7/LQW18C/LQG/LQM18/LQM21*4 /LQP

*1 Except LQH2MC/LQH32P/LQH3NP/LQH43C

*2 LQM21D(22 - 47μH)/LQM21F(4.7 - 47μH)/LQM21N(2.7 - 4.7μH) only.

*3 LQM21D(1.0 - 10μH)/LQM21F(1.0 - 2.2μH)/LQM21N(0.1 - 2.2μH) only.

*4 LQM21D(1.0 - 10μH)/LQM21F(1.0 - 2.2μH)/LQM21N(0.1 - 2.2μH)/LQM21P only.

*5 Except LQP02T/15T

*6 Except LQW21H

*7 Except LQW2BA/LQW2UA

⑨ Electrode (Except LQH□□P/LQM□□P)

•Lead (Pb) Free

Code	Electrode	Series
0	Sn	LQG18H/LQP03T/LQW□□A/ LQW□□C/LQM
2		LQG15H/LQP02T/LQP03T/LQP15T/ LQP□□M/LQH2MC
3	LF Solder	LQW□□H/LQH (Except LQH2MC)
4	Au	LQP03T

⑨ Specification (LQH□□P/LQM□□P Only · Except LQH6PP/LQH88P)

Code	Specification
0	Standard Type
C	Good Bias Current Characteristics Type

⑧⑨ Thickness (LQH6PP/LQH88P Only)

Code	Dimension (T)
38	3.8mm
43	4.3mm